FEATURES AND SPECIFICATIONS



0.80mm (.031") Pitch iPass Integrated Dual-Port 26-Circuit Stacked Connector

75758 Integrated Dual Port Connector



iPass Integrated Dual Port Connector (Series 75758)

Molex's iPass integrated dual-port 26-circuit stacked connector integrates two individual-ports into a single assembly and accepts standard external cables

The iPass Interconnect System is ideal for the growing server-storage market. The dual- port 26-circuit stacked connector is the latest addition to the existing iPass product family. Each port on this connector includes eight differential pairs, creating four lanes, each capable of 12 Gbps. Total bandwidth enabled through the dual-port assembly is 96 Gbps.

Input/Output (1/O) bandwidth requirements are increasing exponentially with evolving new standards. The iPass dual-port connector will enable system implementers to meet these requirements.

Features and Benefits

- Doubles the port density and prevents increase in "beachfront" compared to the current singleport product
- Integrated press-fit connector assembly with cage provides one-step placement to PCB
- Robust guide pins located on each side of the cage ensures assembly alignment to PCB
- Four integral screw-mount hold downs applied from bottom of PCB provide optimal retention of die-cast assembly to PCB without taking up additional board real estate

The currently available solution requires a belly-to-

belly implementation, which may not be an option for

The new stacked dual-port connector makes it possible

systems with boards fixed to one side of the chassis.

to double the I/O bandwidth without a mechanical

Molex's iPass dual-port stacked connector accepts

standard external iPass cables, for standards such as

I/O (SRIO), and Ethernet. For more information on

Serial Attach SCSI (SAS), Serial ATA (SATA), Serial Rapid

iPass products, visit www.molex.com/product/ipass.html.

redesign of the system enclosures.

- Front elastomeric EMI gasket provides excellent EMI protection to the system face plate
- Four ground-pad alleys are located at the rear of the die cast assembly to provide ease of routing on the top layer of the PCB

SPECIFICATIONS

Reference Information

Packaging: Trays UL File No.: Pending CSA File No.: Pending Mates With: Series 74547 Cable Assembly Designed In: Millimeters

Electrical

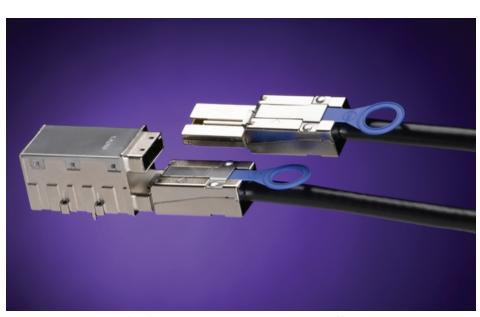
Voltage: 30V Current: 0.5A Dielectric Withstanding Voltage: 500V DC Insulation Resistance: 1000 Megohms

Mechanical

Insertion Force to PCB: 25N (5.62 lb) per pin max. Mating Force: 82.5N (18.55 lb) max. Unmating Force: 26.5N (5.96 lb) max. Durability: 250 cycles

Physical

Housing: LCP Contact: Copper (Cu) Alloy Plating: Contact Area - 0.76µm min Gold (Au) Compliant Area - 0.76µm min Tin/Lead (Sn/Pb) Under plating - 2.54µm min Nickel (Ni) PCB Thickness: 1.57mm (.062") min RoHS compliant: Yes Operating Temperature: -40 to +80°C



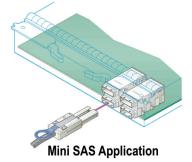
iPass Integrated Dual Port Connector mating to two Mini SAS 4x Cables (Series 74547)



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75758 Integrated Dual Port Connector

SBB (Storage Bridge Bay) Controller

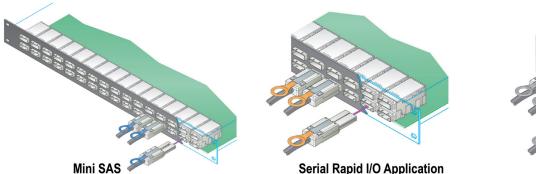


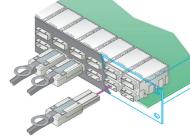
1U Enclosures and Blades

Server/Storage/HPC/Telecom Applications

- High-density blades

Servers, JBODs (just a bunch of discs), switches and routers
 RAID controllers and storage bridge bay controllers





Ethernet Application

ORDERING INFORMATION

Order No.	Channel Count	Circuit Size	Plating
75758-0101	8 (16 differential pairs)	52	0.76µm Gold (Au)

www.molex.com/product/ipass.html

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